

SENSITIVE GATE TRIACS

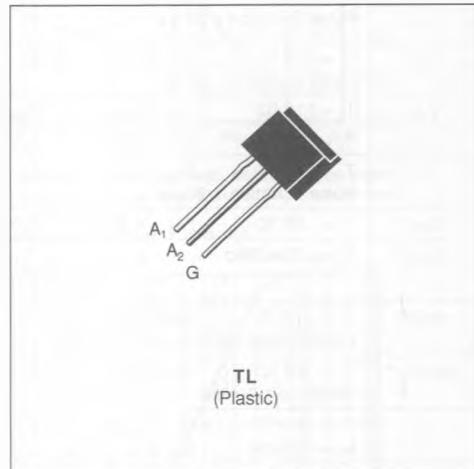
- GLASS PASSIVATED CHIP
- HIGH SURGE CURRENT

DESCRIPTION

Low power triacs suited for 50 and 60 Hz up to 380 VRMS.

APPLICATIONS

- CONTROL SPEED FOR LITTLE MOTORS : ELECTRIC PUMP OR VENTILATOR, SEWING MACHINE
- RELAY, DETECTOR, ALARM SYSTEM
- ELECTRONIC STARTER FOR LAMP
- HIGH POWER TRIAC DRIVER



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state Current (360° conduction angle)	3	A
$I_{T(RMS)}$	RMS on-state Current on Printed Circuit (360° conduction angle)	1.3 (3)	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_J initial = 25 °C - Half sine wave)	31.5	A
	$t = 8.3 \text{ ms}$	30	
I^2t	I^2t Value for Fusing	4.5	A^2s
di/dt	Critical Rate of Rise of on-state Current (1)	10	$\text{A}/\mu\text{s}$
T_{stg} T_J	Storage and Operating Junction Temperature Range	- 40 to 150 - 40 to 110	$^{\circ}\text{C}$
			$^{\circ}\text{C}$

Symbol	Parameter	TLC116D	TLC226D	TLC336D	TLC386D	Unit
V_{DRM}	Repetitive Peak off-state Voltage (2)	200	400	600	700	V

(1) $I_G = 100 \text{ mA}$ $di/dt = 1 \text{ A}/\mu\text{s}$

(2) $T_J = 110 \text{ }^{\circ}\text{C}$.

(3) With Cu surface = 1 cm².

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to Ambient on Printed Circuit	50 (1)	$^{\circ}\text{C}/\text{W}$
$R_{th(j-i)}$	Junction-leads for 360° Conduction Angle ($F = 50 \text{ Hz}$)	15	$^{\circ}\text{C}/\text{W}$

(1) With Cu surface = 1 cm².

GATE CHARACTERISTICS (maximum values)

$$P_{GM} = 2 \text{ W } (t_0 = 10 \text{ } \mu\text{s})$$

$$I_{GM} = 1 \text{ A } (t_0 = 10 \mu\text{s})$$

$$P_G(\text{AV}) = 0.1 \text{ W}$$

$$V_{GM} = 16 \text{ V } (t_0 = 10 \mu\text{s})$$

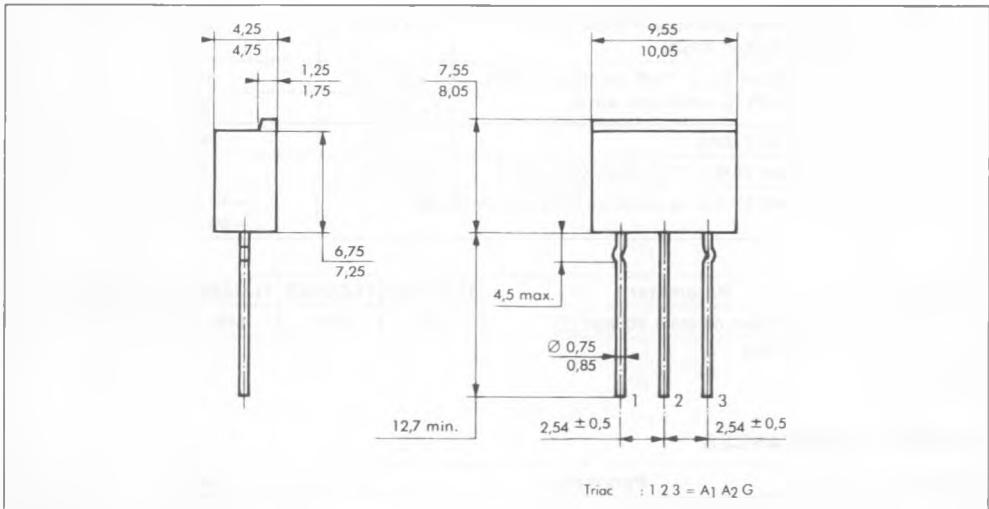
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25^\circ C$	$V_D = 12 V$	$R_L = 33 \Omega$	I-II-III			5	mA
	Pulse Duration > 20 μs			IV			10	
V_{GT}	$T_j = 25^\circ C$	$V_D = 12 V$	$R_L = 33 \Omega$	I-II-III-IV			1.5	V
V_{GD}	$T_j = 110^\circ C$	$V_D = V_{DRM}$	$R_L = 3.3 k\Omega$	I-II-III-IV		0.2		V
I_H^*	$T_j = 25^\circ C$	$I_T = 100 mA$	Gate Open				15	mA
I_L	$T_j = 25^\circ C$	$V_D = 12 V$	$I_G = 20 mA$	I-II-III-IV			15	mA
V_{TM}^*	$T_j = 25^\circ C$	$I_{TM} = 4 A$	$t_p = 10 ms$				1.85	V
I_{DRM}^*	V_{DRM} Specified		$T_j = 25^\circ C$				0.01	mA
			$T_j = 110^\circ C$				0.75	
dv/dt^*	$T_j = 110^\circ C$ Gate Open Linear Slope up to $V_D = 67\% V_{DRM}$					10		V/ μs
$(dv/dt)_c^*$	$T_j = 40^\circ C$	$V_D = V_{DRM}$	$I_T = 4 A$			1		V/ μs
t_{gI}	$T_j = 25^\circ C$ $I_G = 100 mA$	$V_D = V_{DRM}$ $dI_G/dt = 1 A/\mu s$	$I_T = 4 A$	I-II-III-IV		3		μs

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

PACKAGE MECHANICAL DATA

TL Plastic



Cooling method : by convection (method A)

Marking : type number

Marking-type
Weight: 0.8 g

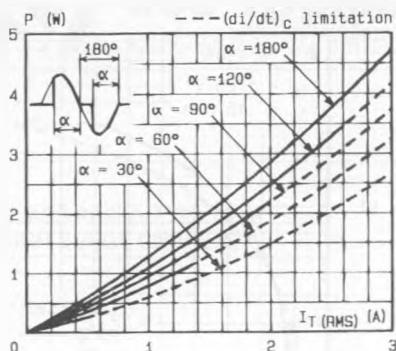


Fig.1 - Maximum mean power dissipation versus RMS on-state current.

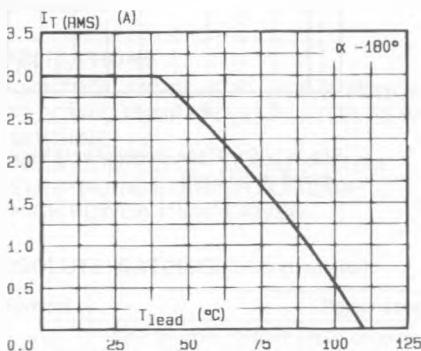


Fig.3 - RMS on-state current versus lead temperature.

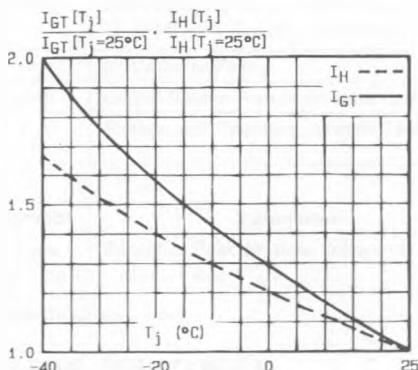


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

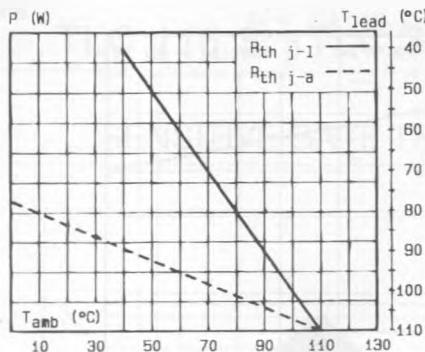


Fig.2 - Correlation between maximum power dissipation and maximum allowable temperatures (T_{amb} and T_{lead}). resistances heatsink + contact.

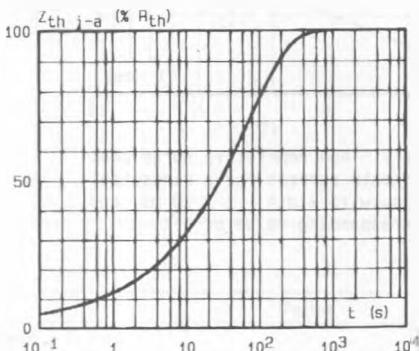


Fig.4 - Thermal transient impedance junction to ambient versus pulse duration.

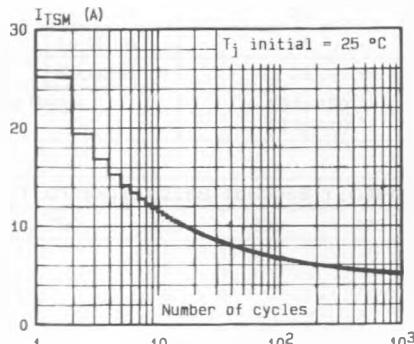


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

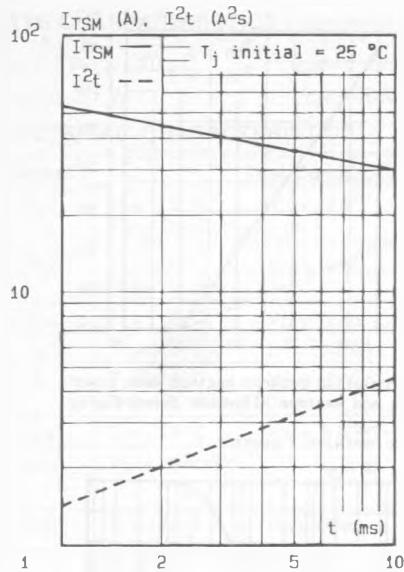


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

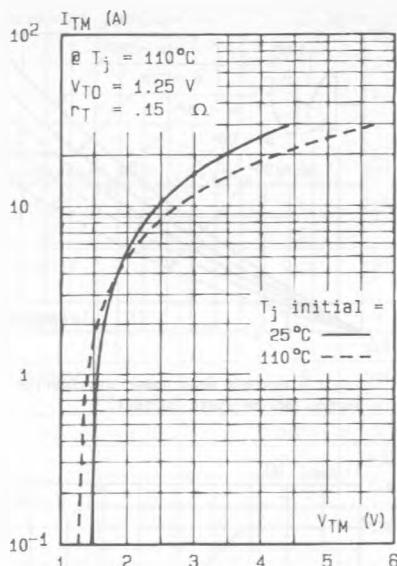


Fig.8 - On-state characteristics (maximum values).